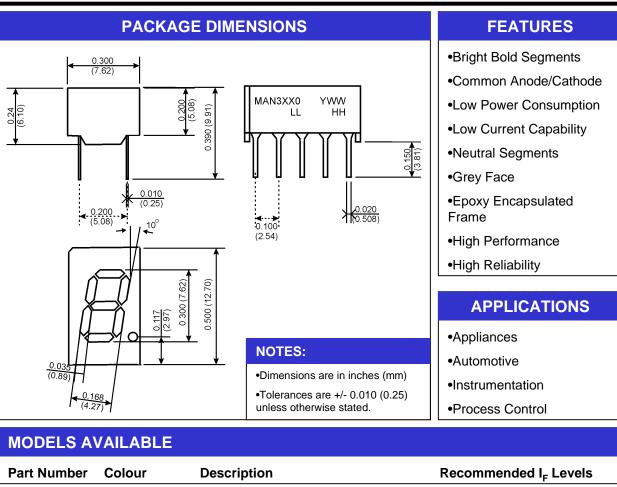


# AlinGaP Red (630nm) MAN3H10, MAN3H40 AlinGaP Red (642nm) MAN3R10, MAN3R40 AlinGaP Yellow MAN3Y10, MAN3Y40 GaP Green MAN3G10, MAN3G40

TR/QTS/030100-002



	•	F
MAN3H10	AllnGaP 630nm Single Digit, RHDP, Common Anode	Low Current (1mA - 5mA)
MAN3H40	AllnGaP 630nm Single Digit, RHDP, Common Cathode	Low Current (1mA - 5mA)
MAN3R10	AllnGaP 642nm Single Digit, RHDP, Common Anode	Low Current (1mA - 5mA)
MAN3R40	AllnGaP 642nm Single Digit, RHDP, Common Cathode	Low Current (1mA - 5mA)
MAN3Y10	AlInGaP Yellow Single Digit, RHDP, Common Anode	Low Current (1mA - 5mA)
MAN3Y40	AllnGaP Yellow Single Digit, RHDP, Common Cathode	Low Current (1mA - 5mA)
MAN3G10	GaP Green Single Digit, RHDP, Common Anode	Low Current (1mA - 5mA
MAN3G40	GaP Green Single Digit, RHDP, Common Cathode	Low Current (1mA - 5mA)

(For other colour options, contact your local area Sales Manager)



<b>ABSOLUTE MAXIMUM RATINGS</b> <sup>(1)</sup> ( $T_A = 25^{\circ}C$ , unless otherwise specified)									
Part Number	MAN3H10	MAN3R10	MAN3Y10	MAN3G10					
Parameter	MAN3H40	MAN3R40	MAN3Y40	MAN3G40	Units				
Continuous Forward Current	25	25	25	25	mA				
(each segment)									
Peak Forward Current	100	100	100	100	mA				
(F = 10KHz, D/F = 1/10)									
Power Dissipation (P <sub>D</sub> )	60	60	60	60	mW				
*Derate Linearly from 25°C	0.36	0.36	0.36	0.36	mW				
Reverse Voltage per Die 5 Volts									
Operating and Storage Temperature Range -40°C to +85°C									
Lead soldering time (1/16 inch from standoffs) 5 seconds @ 230°C									

<b>ELECTRO-OPTICAL CHARACTERISTICS</b> <sup>(1)</sup> ( $T_A = 25^{\circ}C$ , unless otherwise specified)								
Part Number	MAN3H10	MAN3R10	MAN3Y10	MAN3G10				
Parameter	MAN3H40	MAN3R40	MAN3Y40	MAN3G40	Units	Test Condition		
Luminous intensity <sup>(2)</sup> (I <sub>v</sub> )								
Minimum (Standard Current)	Note 4	Note 4	Note 4	1500	ucd	I <sub>F</sub> = 10mA		
Typical (Standard Current)	Note 4	Note 4	Note 4	2500	ucd	I <sub>F</sub> = 10mA		
Minimum (Low Current)	510	510	510	510	ucd	I <sub>F</sub> = 2mA		
Typical (Low Current)	1000	1000	1000	1000	ucd	I <sub>F</sub> = 2mA		
Forward Voltage (V <sub>F</sub> )								
Typical (Standard Current)	2.05	2.05	2.05	2.05	Volts	I <sub>F</sub> = 10mA		
Maximum (Standard Current)	2.45	2.45	2.45	2.45	Volts	I <sub>F</sub> = 10mA		
Typical (Low Current)	1.80	1.80	1.80	1.80	Volts	I <sub>F</sub> = 2mA		
Maximum (Low Current)	2.20	2.20	2.20	2.20	Volts	I <sub>F</sub> = 2mA		
Peak Wavelength	632	639	591	565	nm	I <sub>F</sub> = 10mA		
Dominant Wavelength	624	631	585	570	nm	I <sub>F</sub> = 10mA		
Spectral Line 1/2 Width	20	20	20	20	nm	I <sub>F</sub> = 10mA		
Reverse B <sup>(3)</sup> .Voltage (V <sub>R</sub> )	5	5	5	5	Volts	I <sub>R</sub> = 100uA		

NOTES:

(1) Data per individual LED element

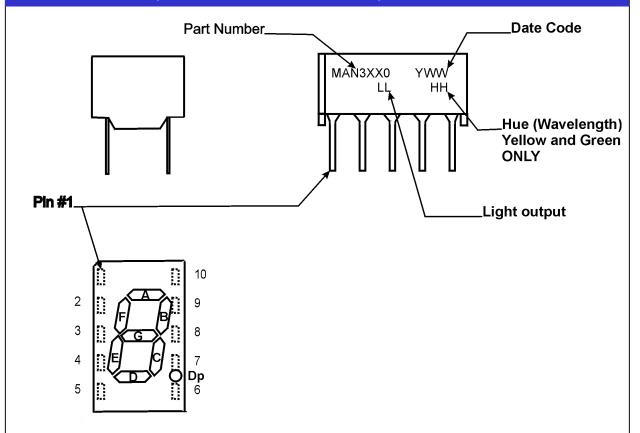
(2) Luminous intensity (ucd) = average light output per segment

(3) B = breakdown

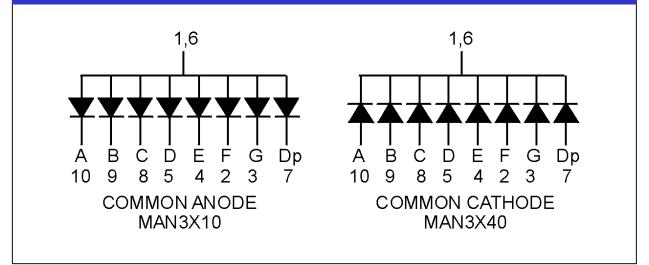
(4) High current operation of these Superbright Displays results in cross-talk (light bleed from a lit to a non lit segment) - maximum drive current recommended to contain cross-talk is 5mA



#### PIN ORIENTATION, SEGMENT IDENTIFICATION, AND PRODUCT MARKING

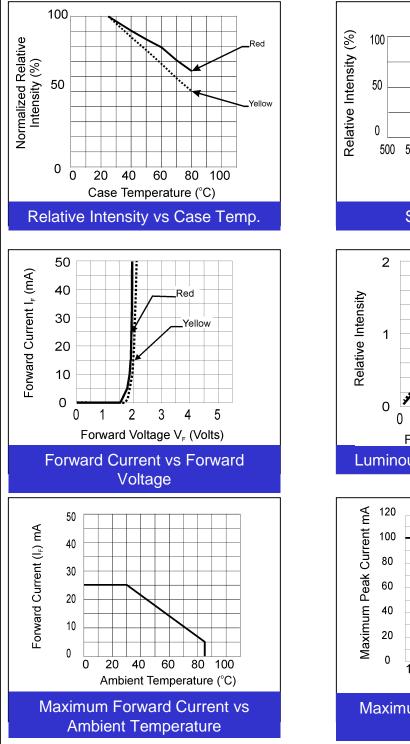


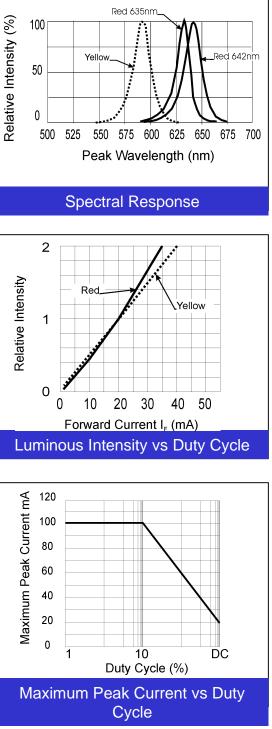
#### **SCHEMATICS**





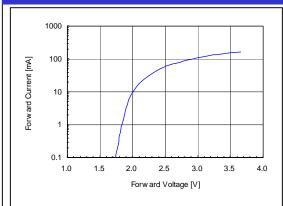
## **GRAPHICAL DATA AllnGaP 630nm (T<sub>A</sub> = 25^{\circ}C, unless otherwise specified)**



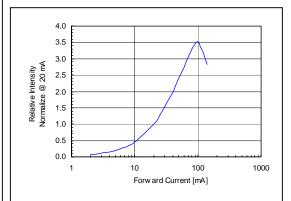




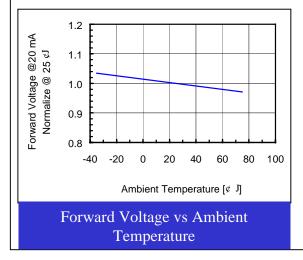
#### **GRAPHICAL DATA GaP Green** ( $T_A = 25^{\circ}C$ , unless otherwise specified)

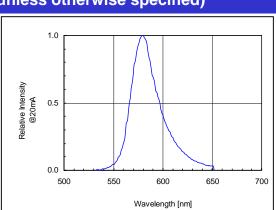


#### Forward Current vs Forward Voltage

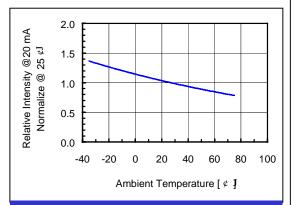


#### Relative Intensity vs Forward Current





#### Spectral Response



Relative Intensity vs Ambient Temperature



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- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.